

DECLARATION FOR PATENT APPLICATION

Docket Number (Optional)

MR1197-505

As a below named inventor, I hereby declare that:

My residence, post office address and citiz	zenship are as stated below	next to my name.	
I believe I am the original, first and sole in names are listed below) of the subject ma METALLIZED FIBER STRUCTUR	tter which is claimed and for	which a patent is sought on the inv	
which is attached hereto unless the follow	ing box is checked:	,	
was filed on	as United States A	pplication Number or PCT Internatio	nal Application
Number			
			•
I hereby state that I have reviewed and ur amended by any amendment referred to a I acknowledge the duty to disclose informa I hereby claim foreign priority benefits u or inventor's certificate, or § 365(a) of any United States, listed below and have also certificate or PCT International application Prior Foreign Application(s)	above. ation which is material to pail ander 35 U.S.C. § 119(a)-(c PCT International application identified below, by checking	entability as defined in 37 CFR §1.5 d) or § 365(b) of any foreign applic on which designated at least one co g the box, any foreign application fo	56. cation(s) for patent untry other than the r patent or inventor's
(Number)	(Country)	(Day/Month/Year Filed)	
(113.11251)	(County)	(Baymona roal rady	
(Number)	(Country)	(Day/Month/Year Filed)	L
I hereby claim the benefit under 35 U.S.C	. § 119(e) of any United Stat	es provisional application(s) listed b	elow.
(Application Number)	(Filing Date		
is not disclosed in the prior United States 35 U.S.C. § 112. I acknowledge the duty to disclose informativa available between the filing date of the prior to the	ation which is material to par	entability as defined in 37 CFR § 1.	56 which became
(Application Number)	(Filing Date	(Status-patenteo	, pending, abandoned)
(Application Number) I hereby appoint the following attorney(s) and Trademark Office connected therewith Address all telephone calls to Address all correspondence to	DAMID I KLEIN, ESQ , F	this application and to transact all b RG, ESQ., REG. # 26,049; REG. # 33,253; JUN Y. LEE, ESQ., F RG at telephone number 410-465-66 LEE R DRIVE-SUITE 101	REG. # 40,262
I hereby declare that all statements made and belief are believed to be true; and furt and the like so made are punishable by fir and that such willful false statements may Full name of sole or first inventor (given not be inventor's signature with the citizenship Taiwan, R.O.C. Mailing Address 5F-1, No. 11, Late Taipei Hsien, Taipei Hsien, Taiwan, R.O.C. Mailing Address 4F, No. 27, Alle Taipei Hsien, T	ther that these statements we not imprisonment, or both, jeopardize the validity of the ame, family name) June 75, Jung Hua Routwan, R.O.C. given name, family name) 22, Lane 99, Zi	ere made with the knowledge that we under Section 1001 of Title 18 of the application or any patent issued thing Shen Lien (Lien is Fate Date January 8, ad, Shen Shar Chang, Hung-En Chen (Chen is Fate Date January 8)	willful false statements e United States Code ereon. mily Name) 2002 Family Name)
\overline{X} Additional Inventors are being na	med on senarately numbers	d sheets attached hereto	

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